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NTTFS4H07N

[MOSFET](#) – Power, Single, N-Channel, μ8-FL
25 V, 66 A

Features

- Optimized Design to Minimize Conduction and Switching Losses
- Optimized Package to Minimize Parasitic Inductances
- Optimized material for improved thermal performance
- These Devices are Pb−Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- High Performance DC-DC Converters
- System Voltage Rails
- Netcom, Telecom
- Servers & Point of Load

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Parameter	Symbol	Value	Units
Drain-to-Source Voltage	V_{DSS}	25	V
Gate-to-Source Voltage	V_{GS}	±20	V
Continuous Drain Current $R_{\theta JA}$ (T_A = 25°C, Note 1)	I_D	18.5	A
Power Dissipation $R_{\theta JA}$ (T_A = 25°C, Note 1)	P_D	2.64	W
Continuous Drain Current $R_{\theta JC}$ (T_C = 25°C, Note 1)	I_D	66	A
Power Dissipation $R_{\theta JC}$ (T_C = 25°C, Note 1)	P_D	33.8	W
Pulsed Drain Current (t_p = 10 μs)	I_{DM}	216	A
Single Pulse Drain-to-Source Avalanche Energy (Note 1) (I_L = 32 A_{pk}, L = 0.1 mH) (Note 3)	E_{AS}	51	mJ
Drain to Source dV/dt	dV/dt	7	V/ns
Maximum Junction Temperature	$T_{J(max)}$	150	°C
Storage Temperature Range	T_{STG}	−55 to 150	°C
Lead Temperature Soldering Reflow (SMD Styles Only), Pb-Free Versions (Note 2)	T_{SLD}	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Values based on copper area of 645 mm^2 (or 1 in^2) of 2 oz copper thickness and FR4 PCB substrate.
2. For more information, please refer to our Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.
3. This is the absolute maximum rating. Parts are 100% UIS tested at T_J = 25°C, V_{GS} = 10 V, I_L = 21 A, E_{AS} = 22 mJ.

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V_{GS}	MAX $R_{DS(on)}$	TYP Q_{GTOT}
4.5 V	7.1 mΩ	5.7 nC
10 V	4.8 mΩ	12.4 nC

PIN CONNECTIONS

μ8−FL (3.3 x 3.3 mm)

(Top View)   (Bottom View)

S
S
S
G

N−CHANNEL MOSFET

D (5–8)

G (4)

S (1,2,3)
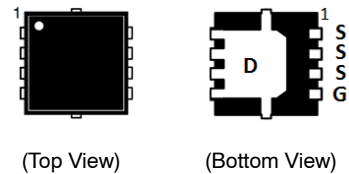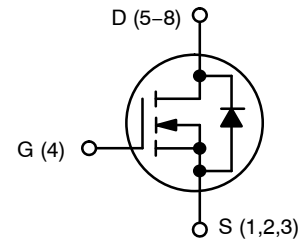
ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 7 of this data sheet.

THERMALCHARACTERISTICS

Parameter	Symbol	Max	Units
Thermal Resistance, Junction-to-Ambient (Note 1 and 4) Junction-to-Case (Note 1 and 4)	$R_{\theta JA}$ $R_{\theta JC}$	47.3 3.7	°C/W

4. Thermal Resistance $R_{\theta JA}$ and $R_{\theta JC}$ as defined in JESD51–3.

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ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Typ	Max	Unit
OFF CHARACTERISTICS							
Drain−to−Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0 V, I_D = 250 μA		25			V
Drain−to−Source Breakdown Voltage Temperature Coefficient	$V_{(BR)DSS}/T_J$				15.5		mV/°C
Zero Gate Voltage Drain Current	I_{DSS}	V_{GS} = 0 V, V_{DS} = 20 V	T_J = 25°C			1.0	μA
			T_J = 125°C			10	
Gate−to−Source Leakage Current	I_{GSS}	V_{DS} = 0 V, V_{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	$V_{GS(TH)}$	V_{GS} = V_{DS}, I_D = 250 μA		1.1		2.1	V
Negative Threshold Temperature Coefficient	$V_{GS(TH)}/T_J$				3.7		mV/°C
Drain−to−Source On Resistance	$R_{DS(on)}$	V_{GS} = 10 V	I_D = 30 A		3.8	4.8	mΩ
		V_{GS} = 4.5 V	I_D = 15 A		5.8	7.1	
Forward Transconductance	g_{FS}	V_{DS} = 12 V, I_D = 15 A			49		S
CHARGES AND CAPACITANCES							
Input Capacitance	C_{ISS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 12 V			771		pF
Output Capacitance	C_{OSS}				525		
Reverse Transfer Capacitance	C_{RSS}				34		
Total Gate Charge	$Q_{G(TOT)}$	V_{GS} = 4.5 V, V_{DS} = 12 V; I_D = 30 A			5.7		nC
Threshold Gate Charge	$Q_{G(TH)}$				2.9		
Gate−to−Source Charge	Q_{GS}				2.5		
Gate−to−Drain Charge	Q_{GD}				1.26		
Total Gate Charge	$Q_{G(TOT)}$	V_{GS} = 10 V, V_{DS} = 12 V; I_D = 30 A			12.4		nC
Gate Resistance	R_G	T_A = 25°C			1.0	2	Ω
SWITCHING CHARACTERISTICS (Note 6)							
Turn−On Delay Time	$t_{d(ON)}$	V_{GS} = 4.5 V, V_{DS} = 12 V, I_D = 15 A, R_G = 3.0 Ω			7.6		ns
Rise Time	t_r				32		
Turn−Off Delay Time	$t_{d(OFF)}$				11.7		
Fall Time	t_f				2.13		
SWITCHING CHARACTERISTICS (Note 6)							
Turn−On Delay Time	$t_{d(ON)}$	V_{GS} = 10 V, V_{DS} = 12 V, I_D = 15 A, R_G = 3.0 Ω			5		ns
Rise Time	t_r				28.3		
Turn−Off Delay Time	$t_{d(OFF)}$				14.5		
Fall Time	t_f				1.65		
DRAIN−SOURCE DIODE CHARACTERISTICS							
Forward Diode Voltage	V_{SD}	V_{GS} = 0 V, I_S = 10 A	T_J = 25°C		0.78	1.1	V
			T_J = 125°C		0.65		
Reverse Recovery Time	t_{RR}	V_{GS} = 0 V, dIS/dt = 100 A/μs, I_S = 10 A			23.4		ns
Charge Time	t_a				11.6		
Discharge Time	t_b				11.8		
Reverse Recovery Charge	Q_{RR}				8		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

5. Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
6. Switching characteristics are independent of operating junction temperatures.
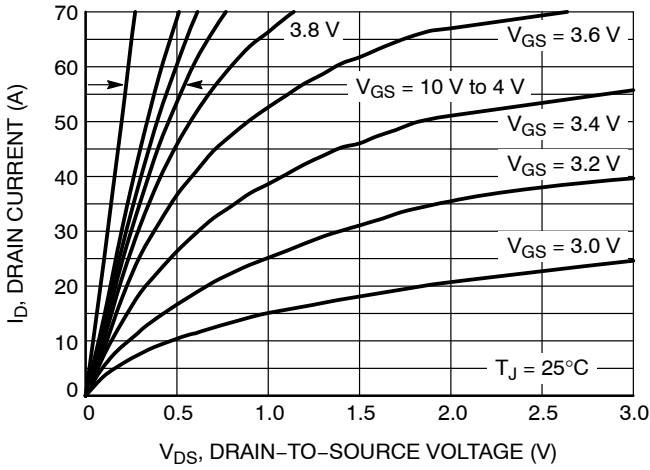
NTTFS4H07N

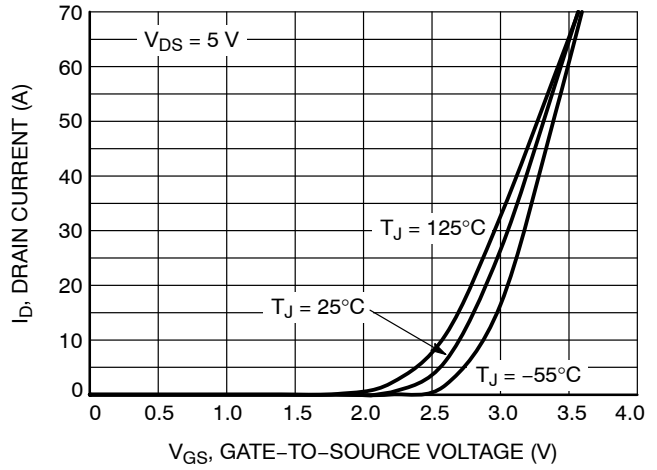## TYPICAL CHARACTERISTICS

Figure 1. On−Region Characteristics

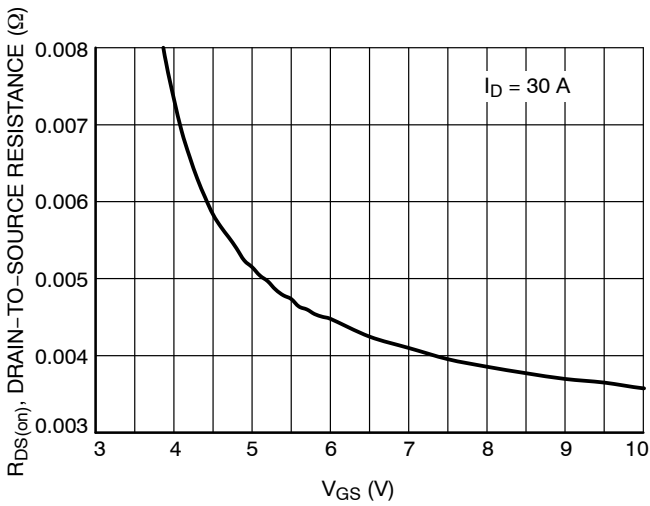Figure 2. Transfer Characteristics
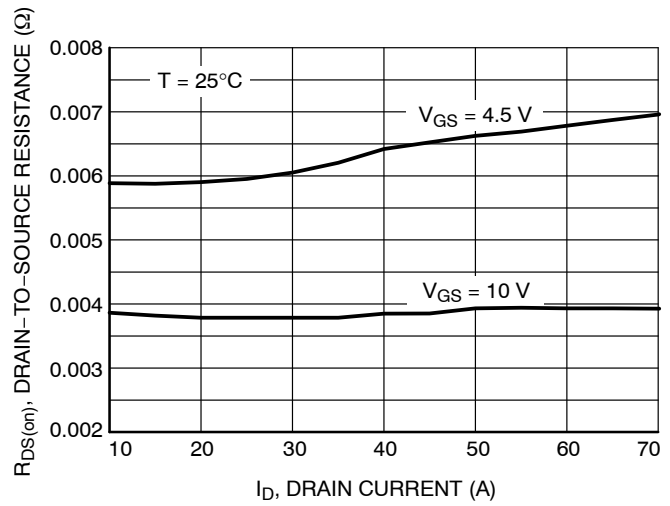

Figure 3. On−Resistance vs. V_{GS}
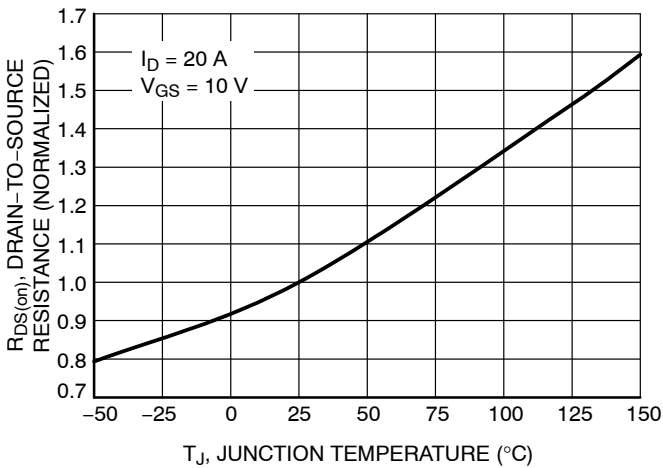

Figure 4. On−Resistance vs. Drain Current and Gate Voltage

Figure 5. On−Resistance Variation with Temperature
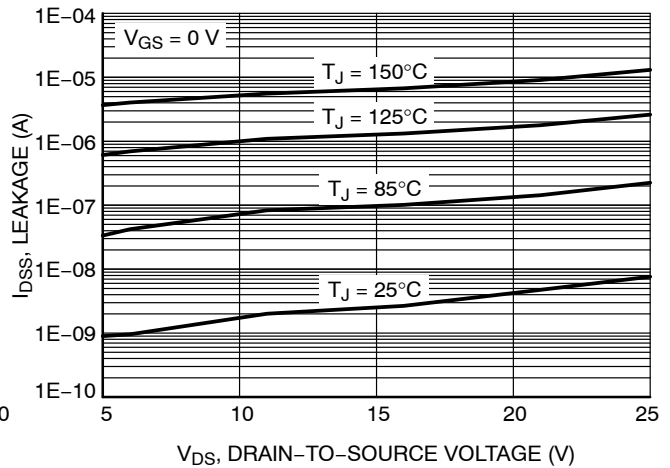

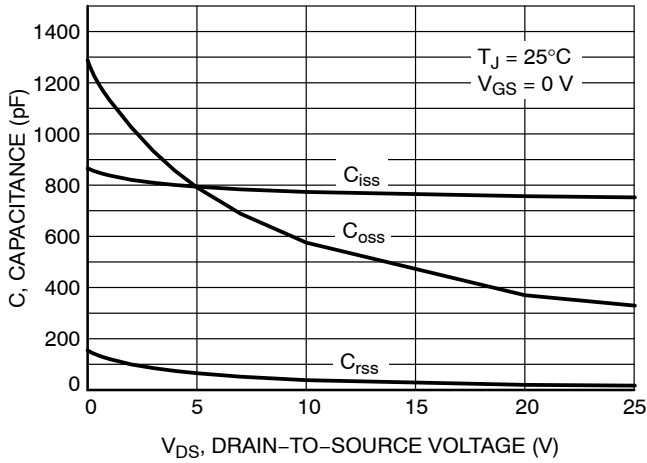Figure 6. Drain−to−Source Leakage Current vs. Voltage

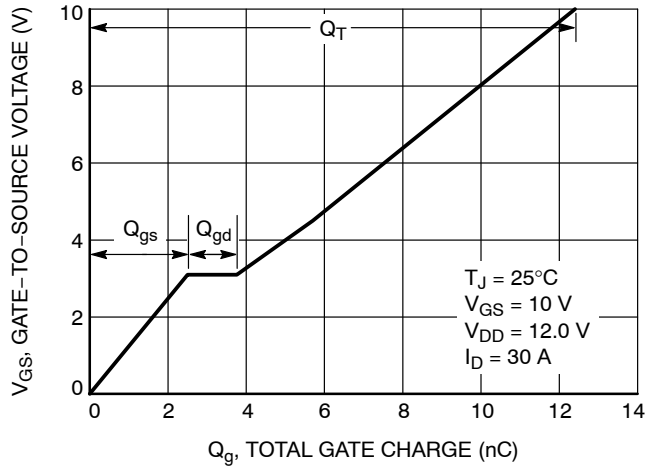## TYPICAL CHARACTERISTICS

Figure 7. Capacitance Variation

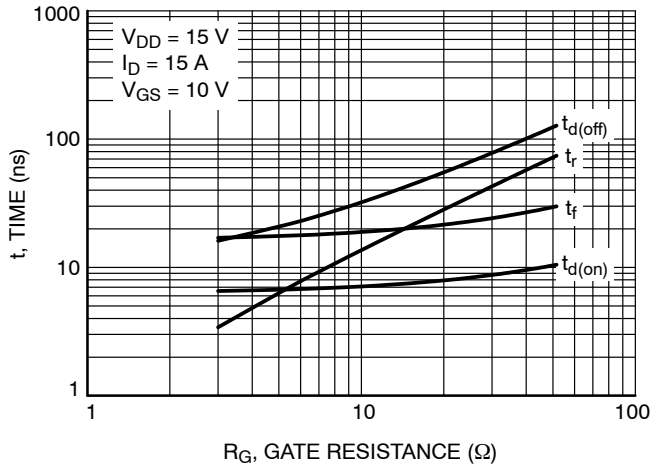Figure 8. Gate–to–Source and
Drain–to–Source Voltage vs. Total Charge

Figure 9. Resistive Switching Time Variation
vs. Gate Resistance
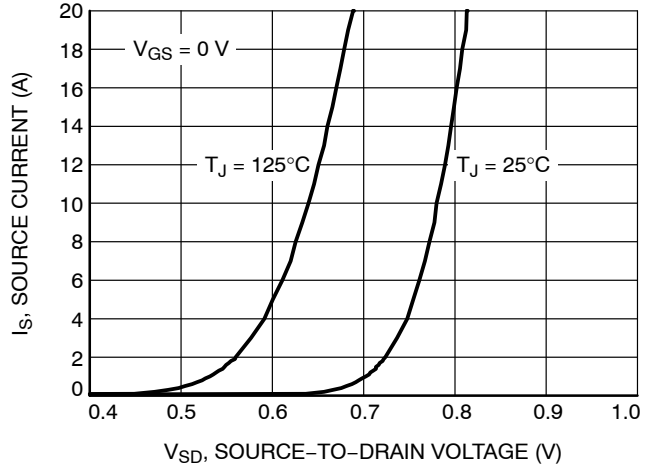
Figure 10. Diode Forward Voltage vs. Current
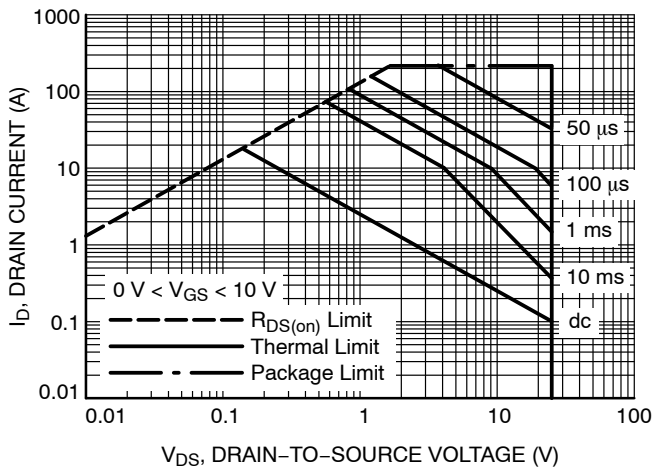
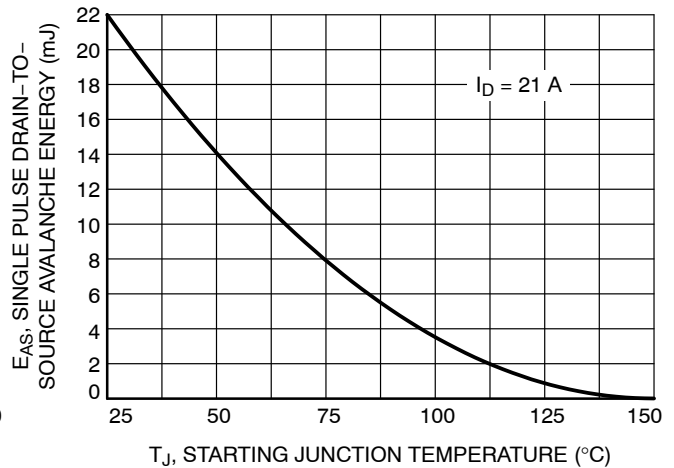Figure 11. Maximum Rated Forward Biased
Safe Operating Area

Figure 12. Maximum Avalanche Energy vs.
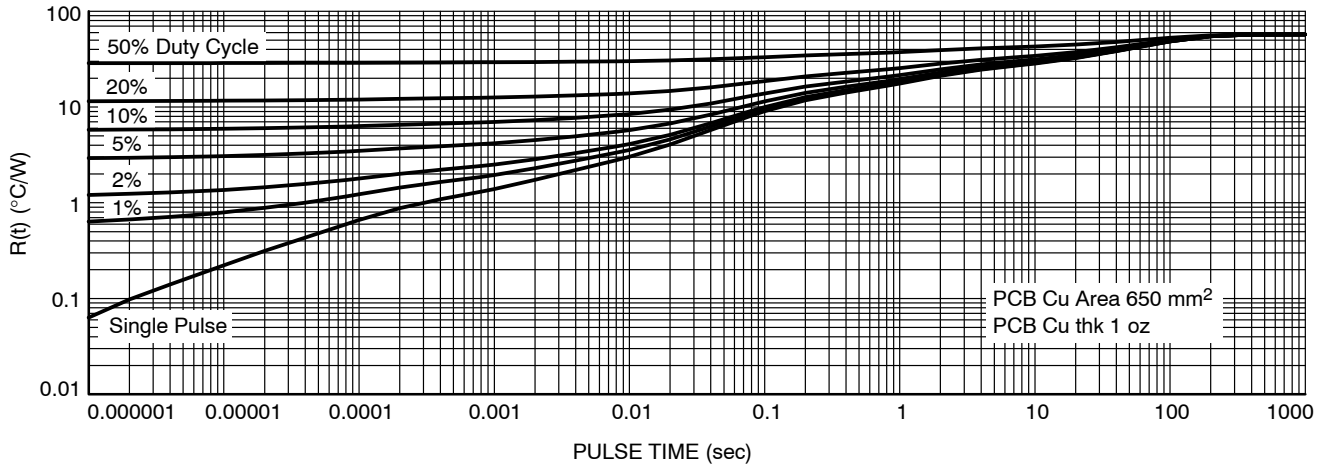Starting Junction Temperature

TYPICAL CHARACTERISTICS

Figure 13. Thermal Characteristics

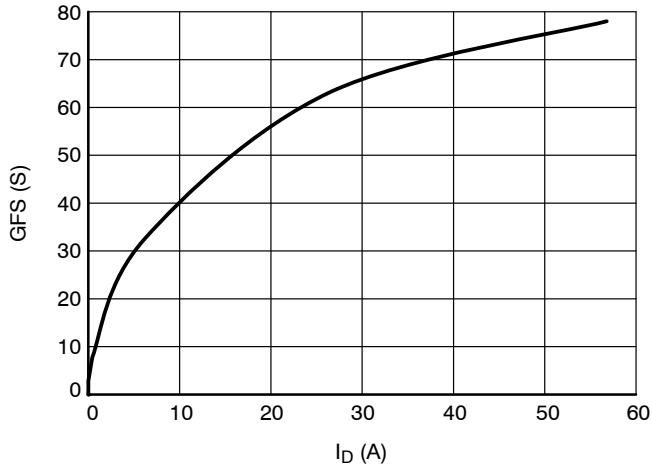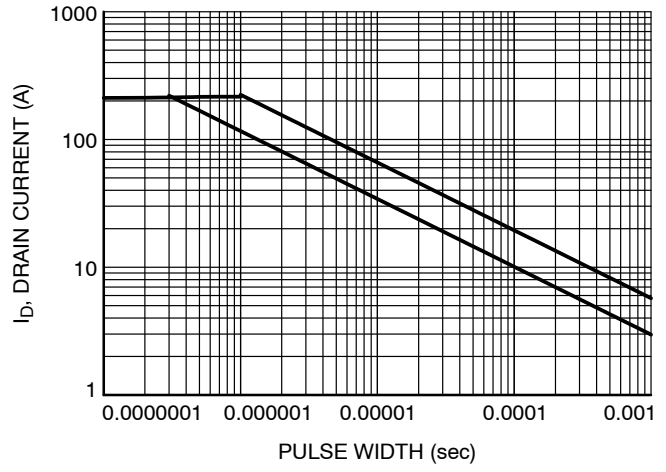
Figure 14. GFS vs. I_D

Figure 15. Avalanche Characteristics

NTTFS4H07N

ORDERING INFORMATION

Device	Package	Shipping[†]
NTTFS4H07NTAG	WDFN8 (Pb-Free)	1500 / Tape & Reel
NTTFS4H07NTWG	WDFN8 (Pb-Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

WDFN8
(μ8FL)
CASE 511AB

MARKING DIAGRAM
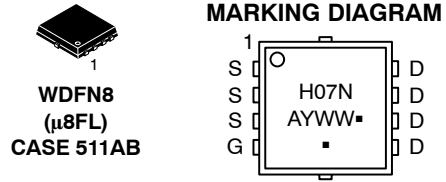
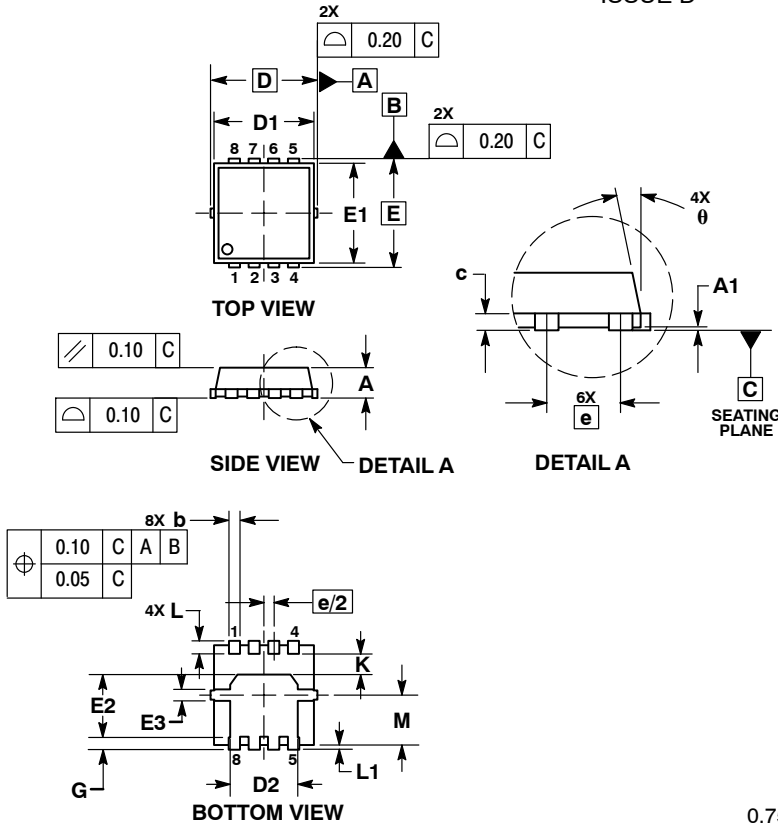|		
H07N	= Specific Device Code	
A	= Assembly Location	
Y	= Year	
WW	= Work Week	
▪	= Pb–Free Package	

(Note: Microdot may be in either location)

PACKAGE DIMENSIONS

WDFN8 3.3x3.3, 0.65P
CASE 511AB
ISSUE D

NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS.

TOP VIEW

SIDE VIEW

DETAIL A

DETAIL A

BOTTOM VIEW

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.70	0.75	0.80	0.028	0.030	0.031
A1	0.00	---	0.05	0.000	---	0.002
b	0.23	0.30	0.40	0.009	0.012	0.016
c	0.15	0.20	0.25	0.006	0.008	0.010
D	3.30 BSC			0.130 BSC		
D1	2.95	3.05	3.15	0.116	0.120	0.124
D2	1.98	2.11	2.24	0.078	0.083	0.088
E	3.30 BSC			0.130 BSC		
E1	2.95	3.05	3.15	0.116	0.120	0.124
E2	1.47	1.60	1.73	0.058	0.063	0.068
E3	0.23	0.30	0.40	0.009	0.012	0.016
e	0.65 BSC			0.026 BSC		
G	0.30	0.41	0.51	0.012	0.016	0.020
K	0.65	0.80	0.95	0.026	0.032	0.037
L	0.30	0.43	0.56	0.012	0.017	0.022
L1	0.06	0.13	0.20	0.002	0.005	0.008
M	1.40	1.50	1.60	0.055	0.059	0.063
θ	0 °	---	12 °	0 °	---	12 °

SOLDERING FOOTPRINT*

DIMENSION: MILLIMETERS
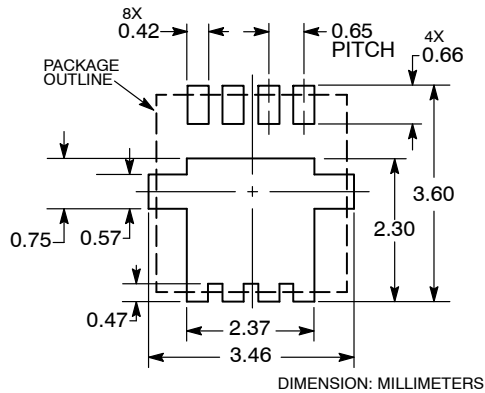
*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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